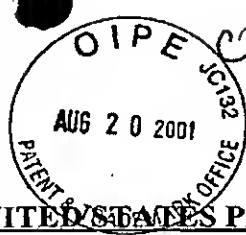
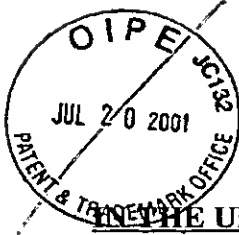


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Applicants: Toshiya SATOH et al.  
Application No.: Not Yet Assigned  
Filing Date: March 16, 2001  
Title: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF  
Art Unit: Not Yet Assigned  
Examiner: Not Yet Assigned

**PRELIMINARY AMENDMENT**

Assistant Commissioner of Patents  
Washington, D.C. 20231

August 20, 2001

RECEIVED  
AUG 23 2001  
TC 2800 MAIL ROOM

Sir:

Prior to examination, please enter thereto the following Preliminary Amendment.

**IN THE SPECIFICATION:**

Please amend the specification as follows:

Page 19, starting at line 11, insert - Fig. 38 is a view showing a semiconductor device according to first, third, forth, sixth, seventh and ninth embodiments of this invention and illustrates the structure of its substantial part.

Fig. 39 is a view showing a semiconductor device according to second, fifth and eighth embodiments of this invention and illustrates the structure of its substantial part.;

Fig. 40 is a view showing a semiconductor device according to tenth, fourteenth, sixteenth, seventeenth, eighteenth, twenty-second, twenty-sixth, twenty-eighth, twenty-ninth, thirtieth, thirty-second and thirty-third embodiments of this invention and illustrates the

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